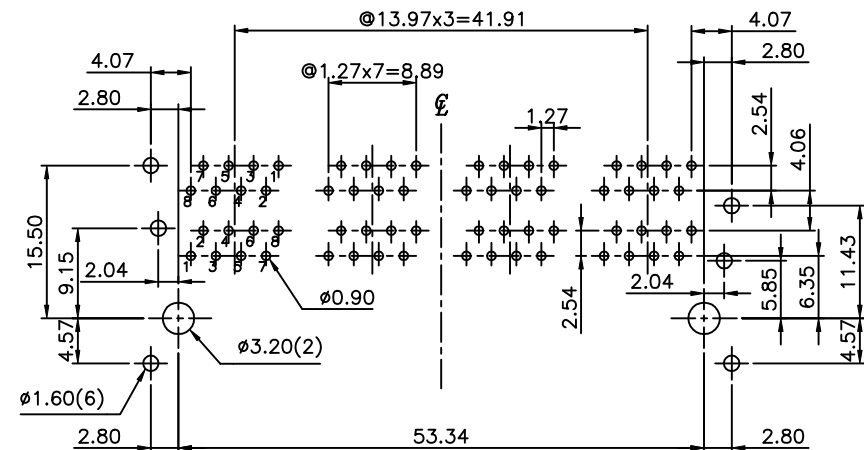
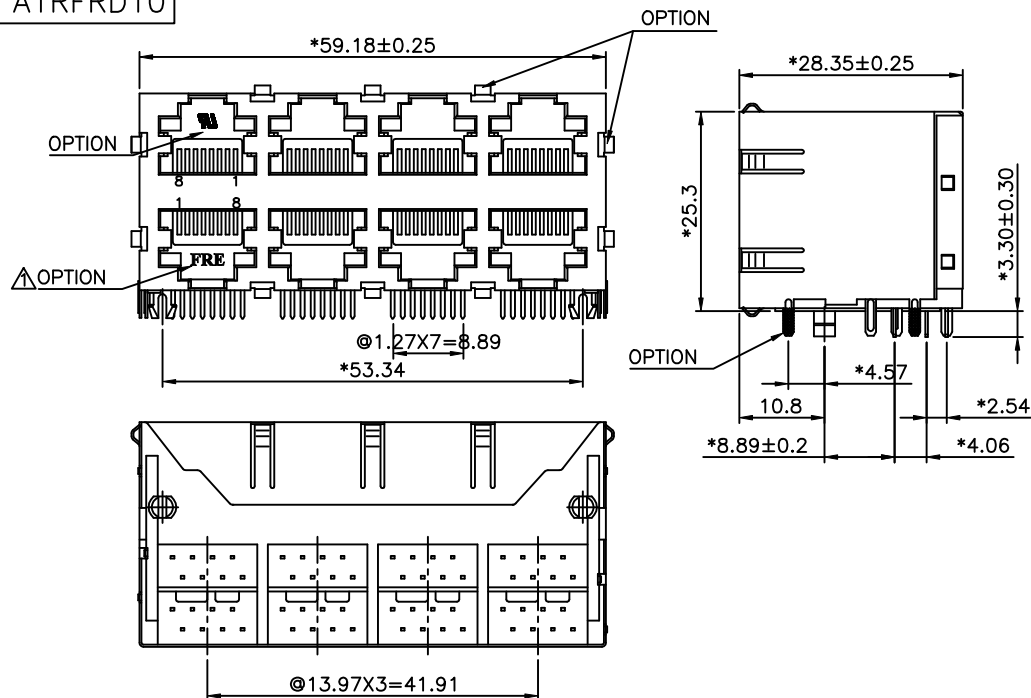


A1RFRD10



PC Board Layout Component Side Shown
Thickness=1.6mm

ROHS PART NUMBER: E5908-XVCXXX-L

1- 3u" 2- 6u" 3-15u"
4-30u" 5-50u"

2-W/ TOP TABS
3-W/ SIDE TABS
4-W/ TOP&SIDE TABS
5-W/ TOP&BOTTOM&SIDE TABS

14-FRONT 4.57 W/O LOGO
1J-FRONT 4.57 W/FRE LOGO W/O UL LOGO

NOTES:**ELECTRICAL:**

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 50 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING & PIN'S & MATERIAL : PBT+30%.G.F BK UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE, t=0.35mm.
3. SHIELD MATERIAL : COPPER ALLOY, t=0.25mm.
4. PLATING : GOLD PLATING OVER NICKEL.
5. OPERATING LIFE : 750 CYCLES MIN.
6. PCB RETENTION PRE-SOLDER : 1 LB MIN.
7. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: -0°C TO 70°C.
3. WAVE SOLDERING TEMPERATURE: 230°C ~250°C (3~5 SECONDS).

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
CUL FILE NO. E163191

DETACHED LISTS	MM (INCH)	DFTO CY	DATE 06/11/05	FULL RISE ELECTRONIC CO., LTD	
	TOLERANCES EXCEPT AS NOTED	CHKD WCM	DATE 2009/12/12		
	MM	MFO	DATE		
	.0 ±0.2	APPV Lusheng	DATE 2009/12/12		
	.00 ±0.15	MATERIAL :		TITLE STAMPED PIN III	
ANGLES ± 0.5		QT'Y :		STACKED GANGED JACK, 2X4	
THIRD ANGLE PROJECTION		FINISH :		DRAWING NO. GE593B51-LC	
		SCALE : 1.5 : 1		/PART NO. SEE NOTE	
		DO NOT SCALE DRAWING		SIZE A3	REV 1
		SHEET 1 OF 1			